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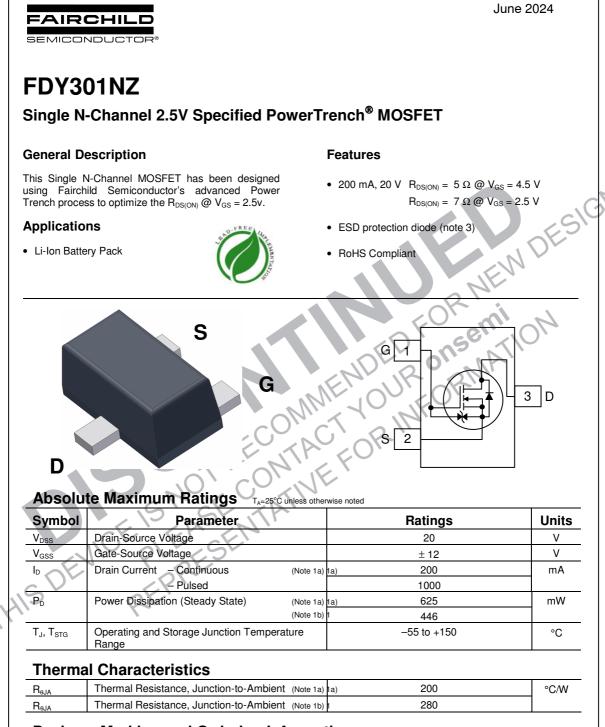


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# Package Marking and Ordering Information

_	Device Marking	Device	Reel Size	Tape width	Quantity
_	D	FDY301NZ	7"	8 mm	3000units

FDY301NZ Single N-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

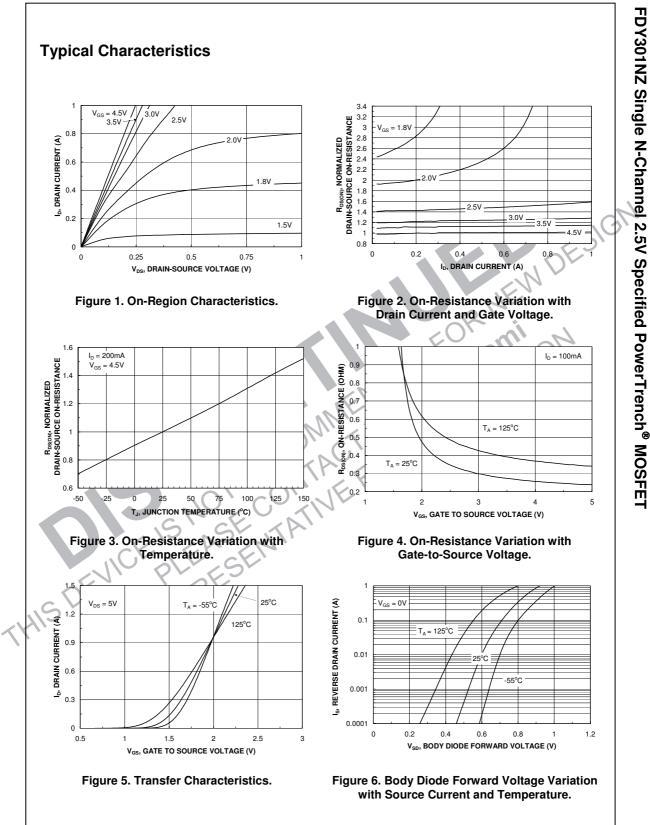
Parameter cteristics Drain–Source Breakdown Voltage Breakdown Voltage Temperature	Test Conditions $V_{GS} = 0 V$ , $I_D = 250 \mu A$	Min	Тур	Max	Units
Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$				
Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$				
Breakdown Voltage Temperature		20			V
Coefficient	$I_D$ = 250 µA, Referenced to 25°C		14		mV/°C
Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
Gate-Body Leakage,				± 10	μA
	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$			ΞI	μA
	VV	0.6		15	V
Gate Threshold Voltage	$I_D = 250 \ \mu\text{A}$ , Referenced to 25 C	0.0	2.8		mV/°C
Temperature Coefficient					Ň
				5	Ω
JI-Resistance					
	$V_{GS} = 1.5 V$ , $I_{D} = 20 \text{ mA}$		$\mathcal{N}$	10	
		2		7	
Forward Transconductance	$V_{DS} = 5 V$ , $I_{D} = 200 mA$		1.1		S
Characteristics			.01		
Input Capacitance	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ ,		60	$\sum$	pF
Output Capacitance	f = 1.0 MHz	0.	20	2	pF
Reverse Transfer Capacitance			10		pF
Characteristics (Note 2)		50°			
Turn–On Delay Time	$V_{DD} = 10 V$ , $h_{D} = 1 A$ ,		6	12	ns
Turn–On Rise Time	$V_{GS} = 4.5 V$ , $R_{GEN} = 6 \Omega$		8	16	ns
Turn–Off Delay Time			8	16	ns
Turn–Off Fall Time	NI. K		2.4	4.8	ns
	$V_{22} = 10$ V $I_2 = 200$ mA			-	nC
					nC
	KP.				nC
			0.20		no
	0		0.7		N
Voltage	$V_{GS} = 0 V$ , $I_S = 150 \text{ mA}$ (Note 2)		0.7	1.2	V
Diode Reverse Recovery Time	$I_{F} = 200 \text{ mA},$		12		nS
Diode Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/µs		3		nC
	Gate-Body Leakage, teristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain-Source Dn-Resistance Forward Transconductance Characteristics nput Capacitance Dutput Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Drain-Source Diode Forward Voltage Diode Reverse Recovery Time	Gate-Body Leakage, $V_{GS} = \pm 12 \text{ V}$ , $V_{DS} = 0 \text{ V}$ VGS = $\pm 12 \text{ V}$ , $V_{DS} = 0 \text{ V}$ VGS = $\pm 4.5 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Gate Threshold Voltage $I_D = 250 \mu \text{A}$ Gate Threshold Voltage $I_D = 250 \mu \text{A}$ , Referenced to 25 °CGate Threshold Voltage $I_D = 250 \mu \text{A}$ , Referenced to 25 °CGate Threshold Voltage $V_{GS} = 4.5 \text{ V}$ , $I_D = 200 \text{ mA}$ Static Drain-Source $V_{GS} = 4.5 \text{ V}$ , $I_D = 175 \text{ mA}$ On-Resistance $V_{GS} = 1.8 \text{ V}$ , $I_D = 200 \text{ mA}$ VGS = 1.5 V, $I_D = 200 \text{ mA}$ VGS = 1.5 V, $I_D = 200 \text{ mA}$ VGS = 1.5 V, $I_D = 200 \text{ mA}$ VGS = 1.5 V, $I_D = 200 \text{ mA}$ VGS = 1.5 V, $I_D = 200 \text{ mA}$ VGS = 1.5 V, $I_D = 200 \text{ mA}$ CharacteristicsNput CapacitancePut CapacitanceNum-On Delay TimeTurn-On Rise TimeTurn-Of Delay TimeTurn-Off Fall TimeVDS = 10 V, $I_D = 200 \text{ mA}$ ,VGS = 10 V, $I_D = 200 \text{ mA}$ ,VGS = 4.5 V, $R_{GEN} = 6 \Omega$ Turn-Off Fall TimeVDS = 10 V, $I_D = 200 \text{ mA}$ ,VGS = 4.5 VGate-Drain ChargeOral Gate ChargeOral Source Diode ForwardVGS = 0 V, $I_S = 150 \text{ mA}$ (Note 2)Oral Source Diode ForwardVGS = 0 V, $I_S = 150 \text{ mA}$ (Note 2)Diode Reverse Recovery TimeIF = 200 mA,	Gate-Body Leakage, $V_{GS} = \pm 12$ V, $V_{DS} = 0$ VVGS = ± 12 V, $V_{DS} = 0$ VVGS = ± 12 V, $V_{DS} = 0$ VCate Threshold VoltageVDS = VGS, ID = 250 $\mu$ A0.6Gate Threshold VoltageID = 250 $\mu$ A, Referenced to 25 C0.6Cate Threshold VoltageID = 250 $\mu$ A, Referenced to 25 C0.6Cate Threshold VoltageVDS = 4.5 V, ID = 200 mA0.6CharacteristicsVGS = 4.5 V, ID = 200 mA0.6Con-ResistanceVGS = 1.8 V, ID = 150 mA0.6VGS = 1.5 V, ID = 200 mAVGS = 1.5 V, ID = 200 mA0.6VDS = 5 V, ID = 200 mAVDS = 5 V, ID = 200 mA0.6CharacteristicsNDS = 10 V, VGS = 0 V, ID = 200 mA0.6Characteristics (Note 2)VDS = 10 V, VGS = 0 V, ID = 200 mA0.6Characteristics (Note 2)VDD = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 $\Omega$ 0.6Characteristics (Note 2)VDS = 10 V, ID = 200 mA, VGS = 4.5 V, RGEN = 6 $\Omega$ 0.6Curun-Off Delay TimeVDS = 10 V, ID = 200 mA, VGS = 4.5 V, RGEN = 6 $\Omega$ 0.6Curun-Off Fall TimeVDS = 10 V, ID = 200 mA, VGS = 4.5 V0.6Cate-Source ChargeVDS = 10 V, ID = 200 mA, VGS = 4.5 V0.6Gate-Drain ChargeVDS = 10 V, ID = 200 mA, VGS = 4.5 V0.6Chain-Source Diode ForwardVGS = 0 V, IS = 150 mA (Note 2)0.6Chain-Source Diode ForwardVGS = 0 V, IS = 150 mA (Note 2)0.6Chain-Source Diode ForwardVGS = 0 V, IS = 150 mA (Note 2)0.6Chain-Source Diode ForwardVGS = 0 V, IS = 150 mA (Note 2)0.6Colde	Gate-Body Leakage, $V_{GS} = \pm 12$ V, $V_{DS} = 0$ VVerificationVerificationVerificationGate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu$ A0.6Gate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25 C2.8Cate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25 C2.8Static Drain-Source $V_{GS} = 4.5$ V, $I_D = 200$ mA2.8Dn-Resistance $V_{GS} = 1.5$ V, $I_D = 175$ mA2.8V_{GS} = 1.5 V, $I_D = 200$ mA $V_{GS} = 1.5$ V, $I_D = 200$ mA2.6Forward Transconductance $V_{DS} = 5$ V, $I_D = 200$ mA1.1Characteristicsnput Capacitance $V_{DS} = 5$ V, $I_D = 200$ mA2.0Forward Transconductance $V_{DS} = 10$ V, $V_{GS} = 0$ V,60Dutput Capacitance $f = 1.0$ MHz2.0Reverse Transfer Capacitance $V_{DS} = 10$ V, $I_D = 1$ A, $V_{GS} = 4.5$ V, $R_{GEN} = 6$ Q8Turn-On Delay Time $V_{DS} = 10$ V, $I_D = 200$ mA, $V_{CS} = 4.5$ V8Turn-Off Delay Time $V_{DS} = 10$ V, $I_D = 200$ mA, $V_{CS} = 4.5$ V0.16Gate-Source Charge $V_{DS} = 10$ V, $I_D = 200$ mA, $V_{CS} = 4.5$ V0.16Gate-Drain Charge $V_{CS} = 0$ V, $I_D = 200$ mA, $V_{CS} = 4.5$ V0.16Gate-Drain Charge $V_{CS} = 0$ V, $I_D = 200$ mA, $V_{CS} = 4.5$ V0.16Gate-Drain Charge $V_{CS} = 0$ V, $I_D = 200$ mA, $I_D = 20$	Gate-Body Leakage, $V_{GS} = \pm 12$ V, $V_{DS} = 0$ V $\pm 10$ VGS = $\pm 4.5$ V, $V_{DS} = 0$ V $\pm 10$ Sate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$ $0.6$ Gate Threshold Voltage $I_D = 250 \ \mu A$ , Referenced to 25 C2.8Gate Threshold Voltage $I_D = 250 \ \mu A$ , Referenced to 25 C2.8Static Drain-Source $V_{GS} = 4.5$ V, $I_D = 200 \ m A$ $5$ On-Resistance $V_{GS} = 2.5$ V, $I_D = 175 \ m A$ $7$ $V_{GS} = 1.5$ V, $I_D = 200 \ m A$ $7$ $V_{GS} = 1.5$ V, $I_D = 200 \ m A$ $10$ $V_{GS} = 1.5$ V, $I_D = 200 \ m A$ $10$ $V_{GS} = 1.5$ V, $I_D = 200 \ m A$ $10$ $V_{GS} = 4.5$ V, $I_D = 200 \ m A$ $10$ $V_{GS} = 4.5$ V, $I_D = 200 \ m A$ $10$ $V_{GS} = 4.5$ V, $I_D = 200 \ m A$ $110$ $V_{GS} = 5$ V, $I_D = 200 \ m A$ $1.1$ $V_{GS} = 1.5$ V, $I_D = 200 \ m A$ $1.1$ $V_{DS} = 10$ V, $V_{GS} = 0$ V, $60$ $O_{Turn-On Delay Time}$ $V_{DD} = 10$ V, $I_D = 1A$ , $V_{GS} = 6.2$ $Turn-On Rise Time$ $V_{DS} = 10$ V, $I_D = 200 \ m A$ , $0.8$ $I_1$ $V_{DS} = 10$ V, $V_{GS} = 6.2$ $8$ $I_1$ $V_{DS} = 10$ V, $V_{GS} = 0$ $0.16$ $I_2$ $0.26$ $0.26$ $Turn-On Rise Time$ $V_{GS} = 10$ V, $I_D = 200 \ m A$ , $0.8$ $I_2$ $0.26$ $0.26$ $I_2$ $V_{GS} = 0$ V, $I_S = 150 \ m A$ , $0.7$ $I_2$ $0.7$ $1.2$ $I_2$ $V_{GS} = 0$ V, $I_S = 150 \ m A$ $0.7$ </td

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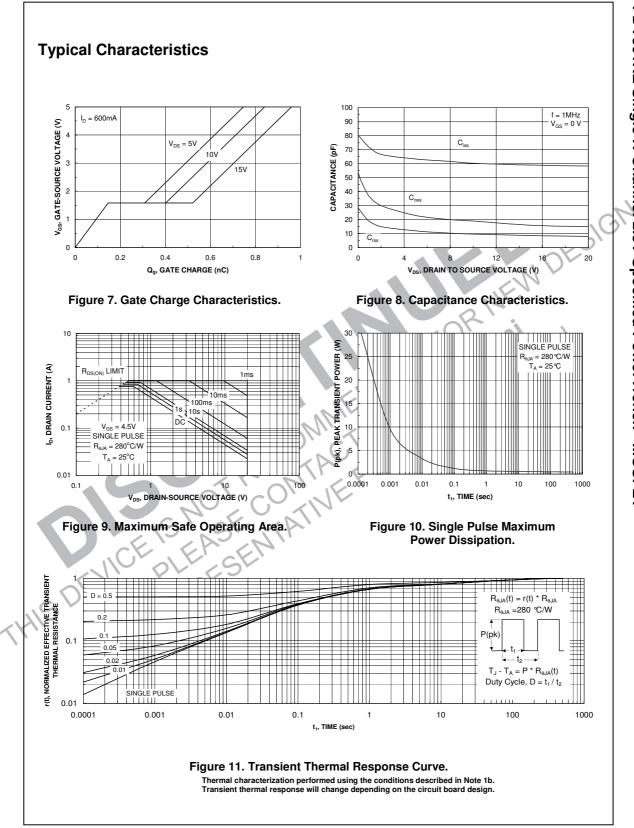
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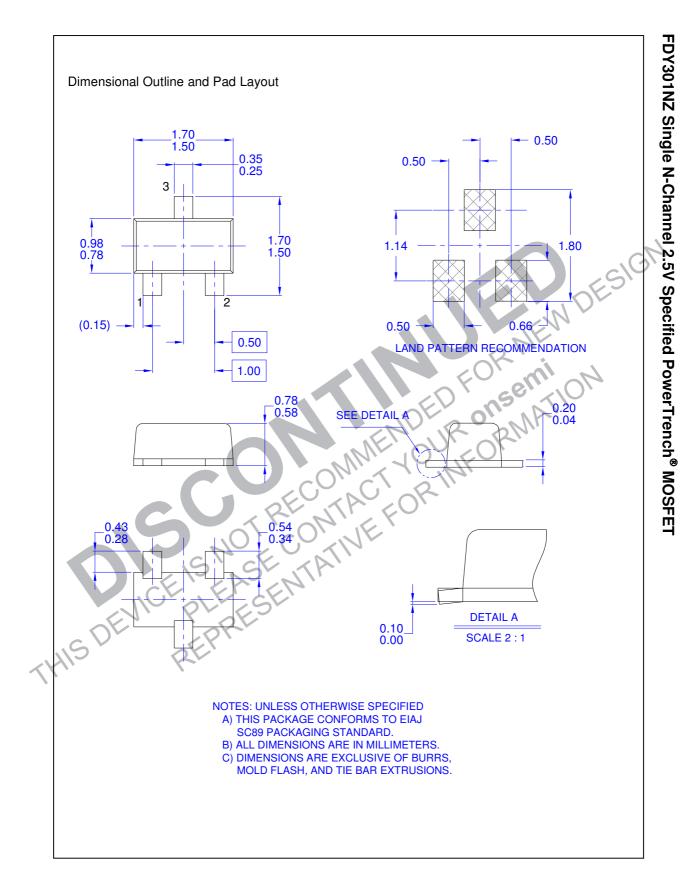
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